

MOSFET – N-Channel, UniFET™ II

500 V, 22 A, 220 mΩ

FDP22N50N

Description

UniFET II MOSFET is **onsemi**'s high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on–state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate–source ESD diode allows UniFET II MOSFET to withstand over 2 kV HBM surge stress. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

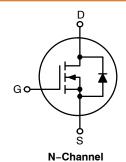
Features

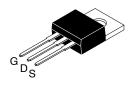
- $R_{DS(on)} = 185 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 11 \text{ A}$
- Low Gate Charge (Typ. 49 nC)
- Low C_{rss} (Typ. 24 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

Applications

- PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

V _{DSS}	R _{DS(on)} MAX	I _D MAX	
500 V	220 mΩ @ 10 V	22 A	





TO-220-3LD CASE 340AT

MARKING DIAGRAM



&Z = Assembly Plant Code &3 = 3-Digit Date Code &K = 2-Digits Lot Run Code FDP22N50N = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
FDP22N50N	TO-220-3LD	1000 Units / Tube

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MOSFET MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	FDP22N50N	Unit	
V _{DSS}	Drain to Source Voltage		500	V
V _{GSS}	Gate to Source Voltage		±30	V
I _D	Drain Current – Continuous (T _C = 25°C)		22	Α
		- Continuous (T _C = 100°C)	13.2	
I _{DM}	Drain Current	- Pulsed (Note 1)	88	Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		1000	mJ
I _{AR}	Avalanche Current (Note 1)		22	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		31.25	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		10	V/ns
P_{D}	Power Dissipation	(T _C = 25°C)	312.5	W
		-Derate above 25°C	2.5	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.

2. L = 4.1 mH, I_{AS} = 22 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C

3. $I_{SD} \le 22$ A, $I_{SD} \le 22$ A, $I_{SD} \le 20$ A/ I_{I} s, $I_{SD} \le 20$ BVDSS, starting I_{I} S = 25°C

THERMAL CHARACTERISTICS

Symbol	Parameter	FDP22N50N	Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case, Max.	0.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	500	-	_	V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	-	0.45	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 500 V, V _{GS} = 0 V	-	-	1	μΑ
		V _{DS} = 400 V, T _C = 125°C	-	-	10	
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±30 V, V _{DS} = 0 V	-	-	±100	nA
ON CHARA	CTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 11 A	-	0.185	0.220	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 11 A	-	24.4	_	S
DYNAMIC (CHARACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	-	2456	3200	pF
C _{oss}	Output Capacitance		-	351	460	pF
C _{rss}	Reverse Transfer Capacitance		-	24	50	pF
Q _{g(tot)}	Total Gate Charge at 10 V	V _{DS} = 400 V, I _D = 22 A, V _{GS} = 10 V (Note 4)	-	49	65	nC
Q _{gs}	Gate to Source Gate Charge		-	15	-	nC
Q _{gd}	Gate to Drain "Miller" Charge]	-	19	-	nC
SWITCHING	G CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V_{DD} = 250 V, I_{D} = 22 A, R_{G} = 4.7 Ω	-	22	55	ns
t _r	Turn-On Rise Time	(Note 4)	-	50	110	ns
t _{d(off)}	Turn-Off Delay Time		-	48	110	ns
t _f	Turn-Off Fall Time]	-	35	80	ns
DRAIN-SO	URCE DIODE CHARACTERISTICS					
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	22	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	88	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 22 A	-	-	1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{SD} = 22 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}$	-	472	-	ns
Q _{rr}	Reverse Recovery Charge	1	_	6.5	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

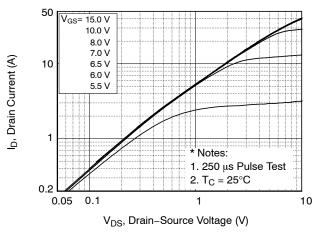


Figure 1. On-Region Characteristics

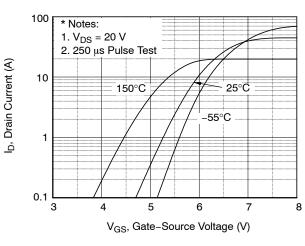


Figure 2. Transfer Characteristics

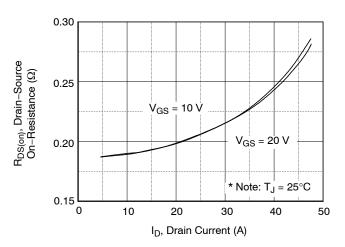


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

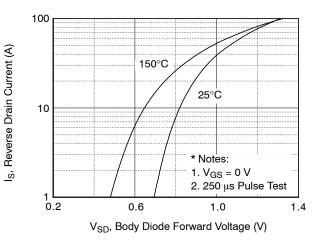


Figure 4. Body Diode Forward Voltage Variation vs. Source Current And Temperature

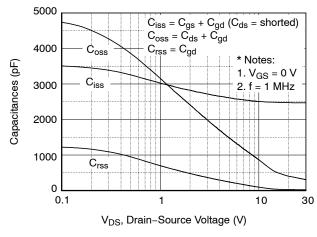


Figure 5. Capacitance Characteristics

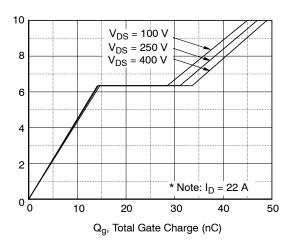


Figure 6. Gate Charge Characteristics

V_{GS}, Gate-Source Voltage (V)

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

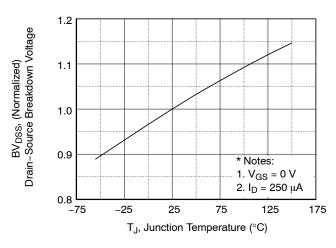


Figure 7. Breakdown Voltage Variation vs. Temperature

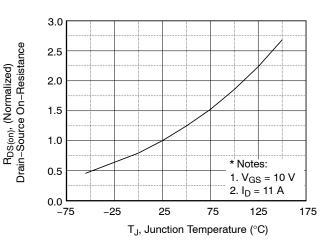


Figure 8. On–Resistance Variation vs. Temperature

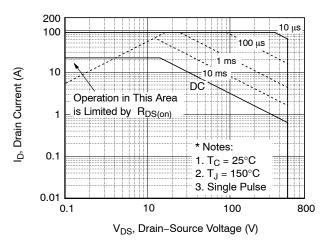


Figure 9. Maximum Safe Operating Area

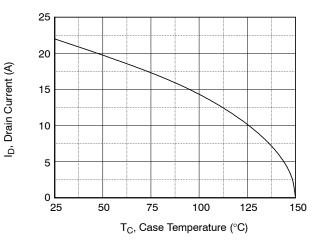


Figure 10. Maximum Drain Current vs.

Case Temperature

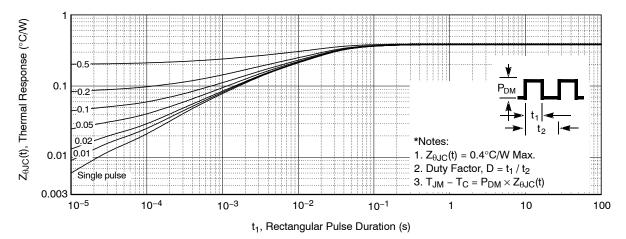


Figure 11. Transient Thermal Response Curve

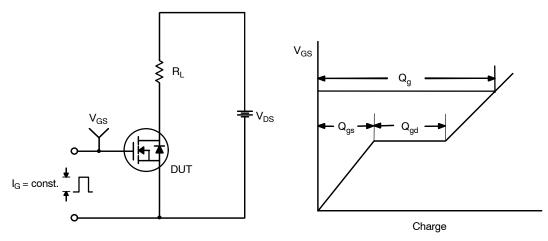


Figure 12. Gate Charge Test Circuit & Waveform

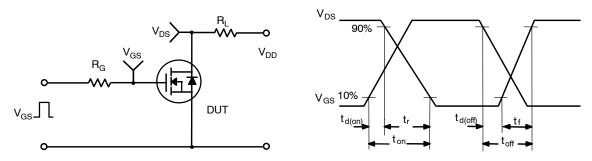


Figure 13. Resistive Switching Test Circuit & Waveforms

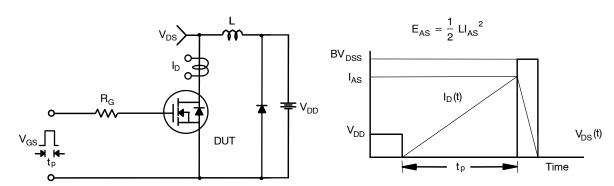


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

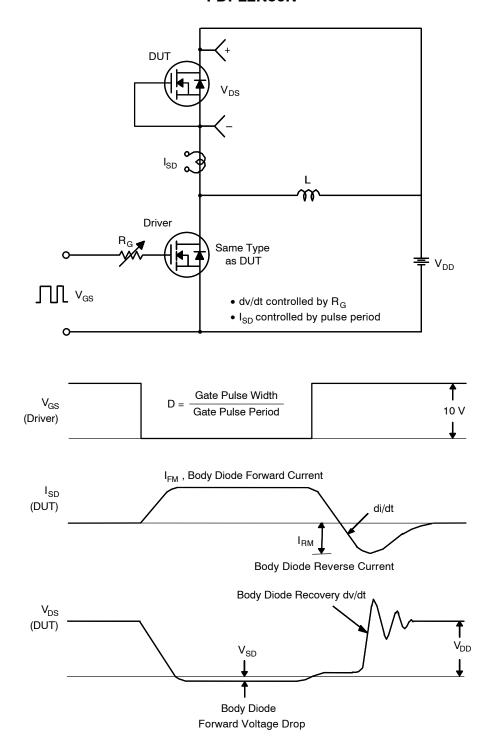
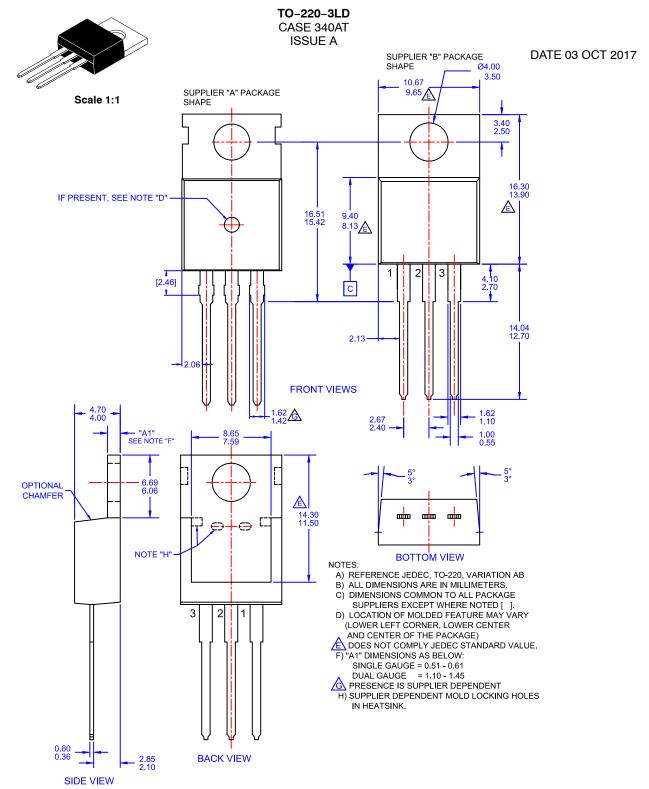


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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